



170 V power Schottky rectifier





Features

- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Low thermal resistance
- · High frequency operation
- Avalanche capability
- ECOPACK[®]2 compliant

Applications

- · Switching diode
- SMPS
- DC/DC converter
- Telecom power

Description

This dual diode common cathode Schottky rectifier is suited for high frequency switched mode power supplies.

Packaged in TO-247, the STPS80170C is optimized for use to enhance the reliability of the application.

Product status				
STPS80170C				
Product summary				
I _{F(AV)} 2 x 40 A				
V _{RRM}	170 V			
T _{j(max.)}	175 °C			
V _{F(typ.)}	0.68 V			



1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	ol Parameter				Unit
V_{RRM}	Repetitive peak reverse voltage			170	V
I _{F(RMS)}	Forward rms current				Α
I _{F(AV)} Av	A	T _c = 150 °C	T _c = 150 °C Per diode		
	Average forward current, δ = 0.5, square wave	T _c = 140 °C	Per device	80	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sin	t _p = 10 ms sinusoidal		
P _{ARM}	Repetitive peak avalanche power	peak avalanche power t_p = 10 μ s, T_j = 125 $^{\circ}$ C			W
T _{stg}	Storage temperature range				°C
Tj	Maximum operating junction temperature (1)			+175	°C

^{1.} $(dP_{tot}/dT_i) < (1/R_{th(i-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter		Max. value	Unit	
R _{th(j-c)}	Junction to case	Per diode	0.7	°C/W	
		Total	0.5	C/VV	
R _{th(c)}	Coupling		0.3	°C/W	

When the diodes 1 and 2 are used simultaneously: $\Delta T_{j \text{ (diode1)}} = P_{\text{(diode1)}} \times R_{\text{th(j-c)}}$ (per diode) + $P_{\text{(diode2)}} \times R_{\text{th(c)}}$

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Doverse legizare gurrent	T _j = 25 °C	$V_R = V_{RRM}$	-		80	μA
'R\'	Reverse leakage current	T _j = 125 °C $V_R - V_R - V_$	VR - VRRM	-	20	80	mA
V _F ⁽²⁾ Forward voltage drop		T _j = 25 °C	I _F = 40 A	-		0.84	V
	Forward voltage drop	T _j = 125 °C		-	0.68	0.74	
		T _j = 25 °C	I _F = 80 A	-		0.96	
		T _j = 125 °C		-	0.80	0.86	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses, use the following equation: P = 0.62 x $I_{F(AV)}$ + 0.003 x I_{F} 2 (RMS)

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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^{2.} Pulse test: t_p =380 μ s, δ < 2%



1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (per diode)

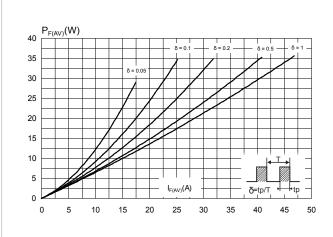


Figure 2. Average forward current versus ambient temperature (δ = 0.5, per diode)

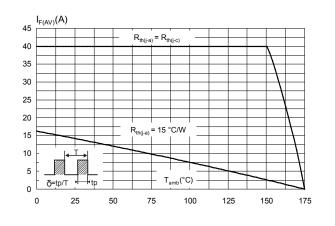


Figure 3. Normalized avalanche power derating versus pulse duration (T_i = 125 °C)

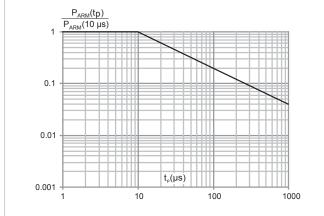
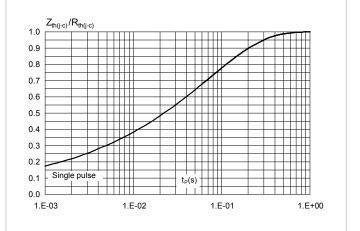


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration



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Figure 5. Reverse leakage current versus reverse voltage applied (typical values, per diode)

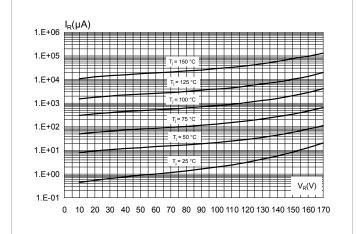


Figure 6. Junction capacitance versus reverse voltage applied (typical values, per diode)

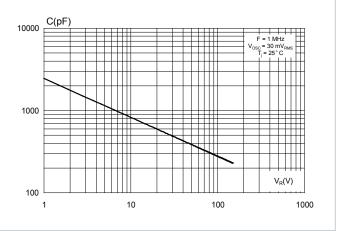


Figure 7. Forward voltage drop versus forward current (per diode, low level)

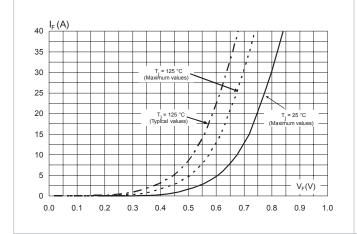
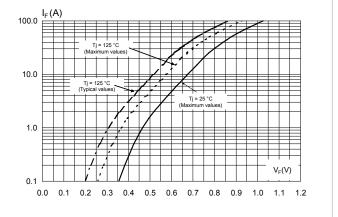


Figure 8. Forward voltage drop versus forward current (per diode, high level)



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 TO-247 package_information

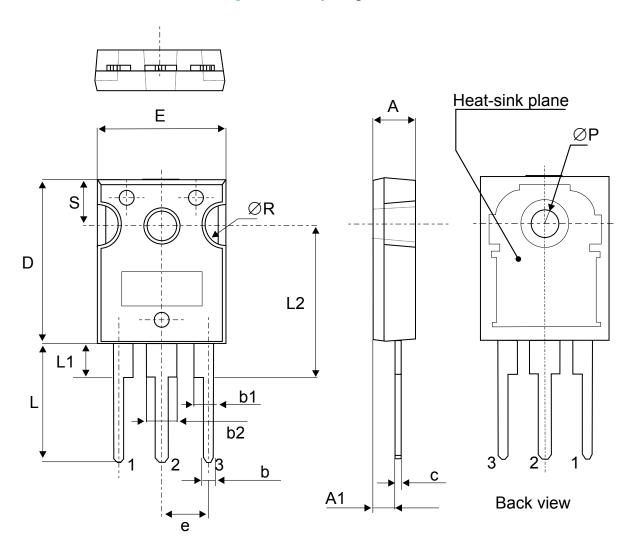
Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.8 N·m

Maximum torque value: 1.0 N·m

Figure 9. TO-247 package outline



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Table 4. TO-247 package mechanical data

		Dimensions						
Ref.		Millimeters			Inches (for reference only)			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	4.85		5.15	0.191		0.203		
A1	2.20		2.60	0.086		0.102		
b	1.00		1.40	0.039		0.055		
b1	2.00		2.40	0.078		0.094		
b2	3.00		3.40	0.118		0.133		
С	0.40		0.80	0.015		0.031		
D	19.85		20.15	0.781		0.793		
Е	15.45		15.75	0.608		0.620		
е	5.30	5.45	5.60	0.209	0.215	0.220		
L	14.20		14.80	0.559		0.582		
L1	3.70		4.30	0.145		0.169		
L2		18.50			0.728			
ØP	3.55		3.65	0.139		0.143		
ØR	4.50		5.50	0.177		0.217		
S	5.30	5.50	5.70	0.209	0.216	0.224		

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3 Ordering information

Table 5. Order code

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS80170CW	STPS80170CW	TO-247	4.36 g	30	Tube

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Revision history

Table 6. Document revision history

Date	Revision	Changes
16-Sep-2005	1	First issue.
18-Jan-2018	2	Minor text change to improve readability. Updated Section 2.1: "TO-247 package information".
09-Aug-2018	3	Updated Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified) and Figure 3. Normalized avalanche power derating versus pulse duration (T_j = 125 °C).

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